

Preparation of multi-channel readout for a GaAs pad sensor

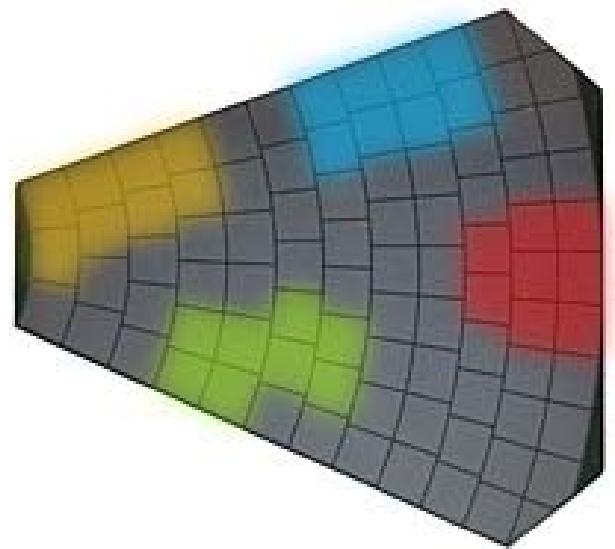
Sensors (1)

- provided by RID Tomsk through JINR Dubna
- wedge of 22.5° ($360^\circ \div 8$), $500\mu\text{m}$ thick
- width of 64mm, subdivided into 12 rings
- 89 pads of $\sim 5 \times 5\text{mm}^2$
- selection by leakage currents



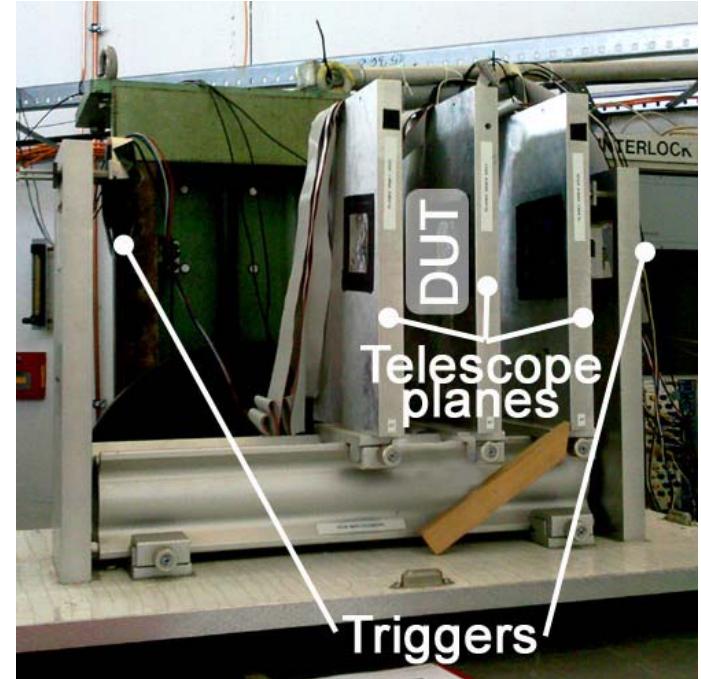
Sensors (2)

- provided by RID Tomsk through JINR Dubna
- wedge of 22.5° ($360^\circ \div 8$), $500\mu\text{m}$ thick
- width of 64mm, subdivided into 12 rings
- 89 pads of $\sim 5 \times 5\text{mm}^2$
- selection by leakage currents
- decide on areas to irradiate:
 - 8 channels in ADC
 - limited mechanical displacement on support
 - different fanout schemes
 - 4 'clusters' of 8 pads each



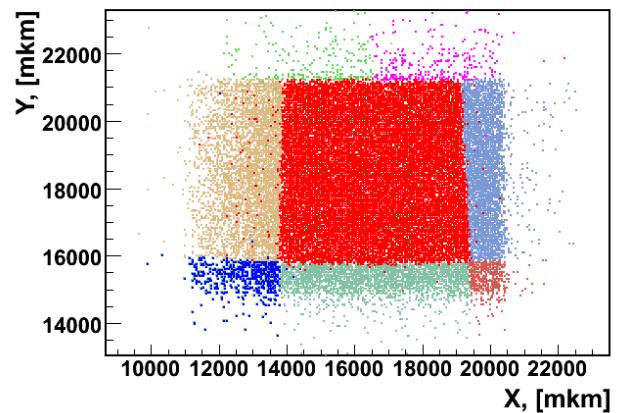
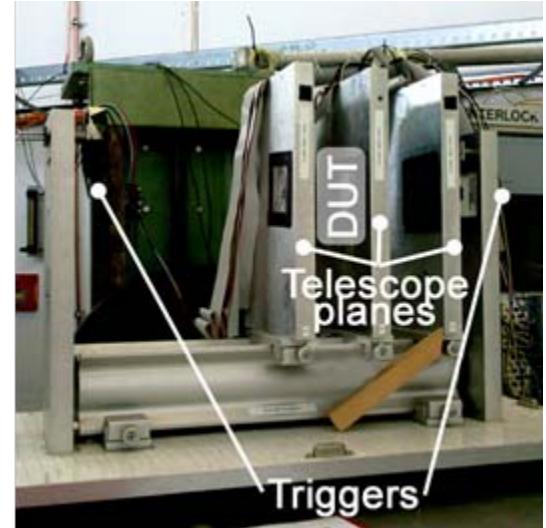
Testbeam facility (1)

- DESY II Synchrotron, Test Beam 22
- Beam spot $\sim 8 \times 8\text{mm}^2$, Gaussian
(crosswise scintillator triggers T1 & T2)
- Silicon Telescope
(3x2 x/y strip detector planes, resolution $3\mu\text{m}$)
- DUT mounted to upright x/y table
remote controlled
(moving range $\sim 40 \times 40\text{mm}^2$, thus covering
max. 8 adjacent pads)



Testbeam facility (2)

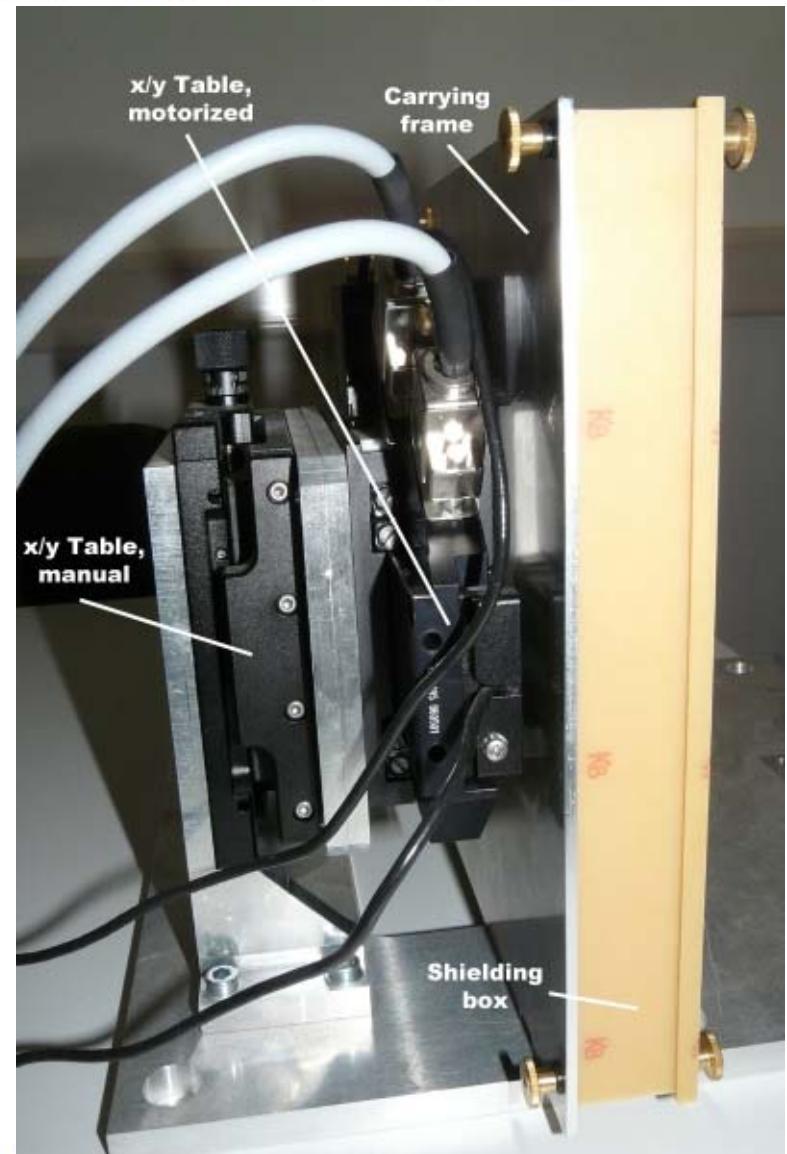
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- DUT mounted to upright x/y table
remote controlled
(moving range $\sim 40 \times 40\text{mm}^2$, thus covering
max. 8 adjacent pads)
- Details on beam energy, rate & telescope
→ see succeeding talks



Testbeam facility (3)

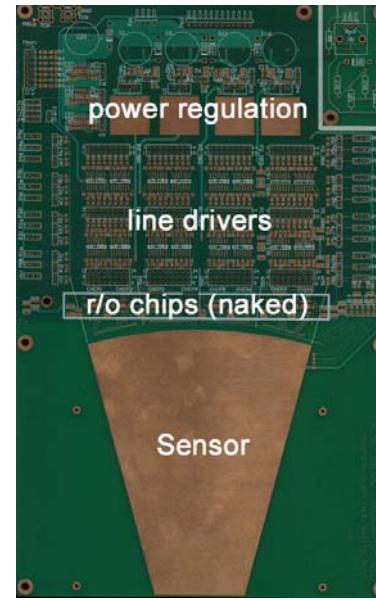


Stand-by box Device under test
(on x/y table)



Frontend Electronics

- RO board

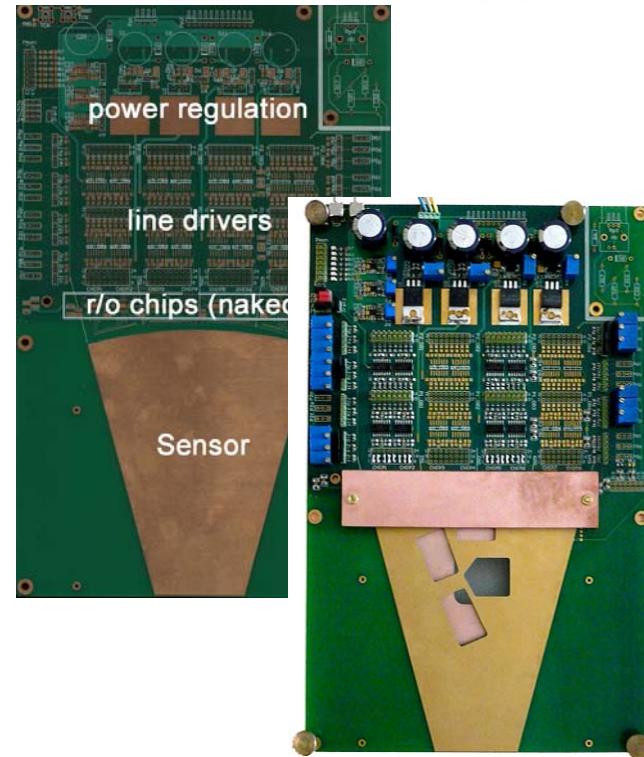


Frontend Electronics

- RO board w/ PreAmp, Drivers

- Power Supplies
- Testpulse coupling
- HV supply & filter

- ADC & DAQ

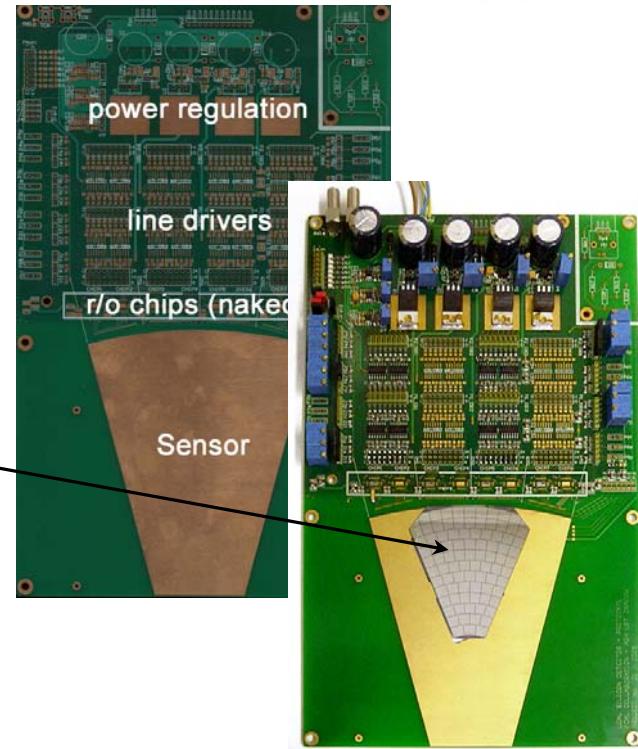


Frontend Electronics

- RO board w/ PreAmp, Drivers + Sensor

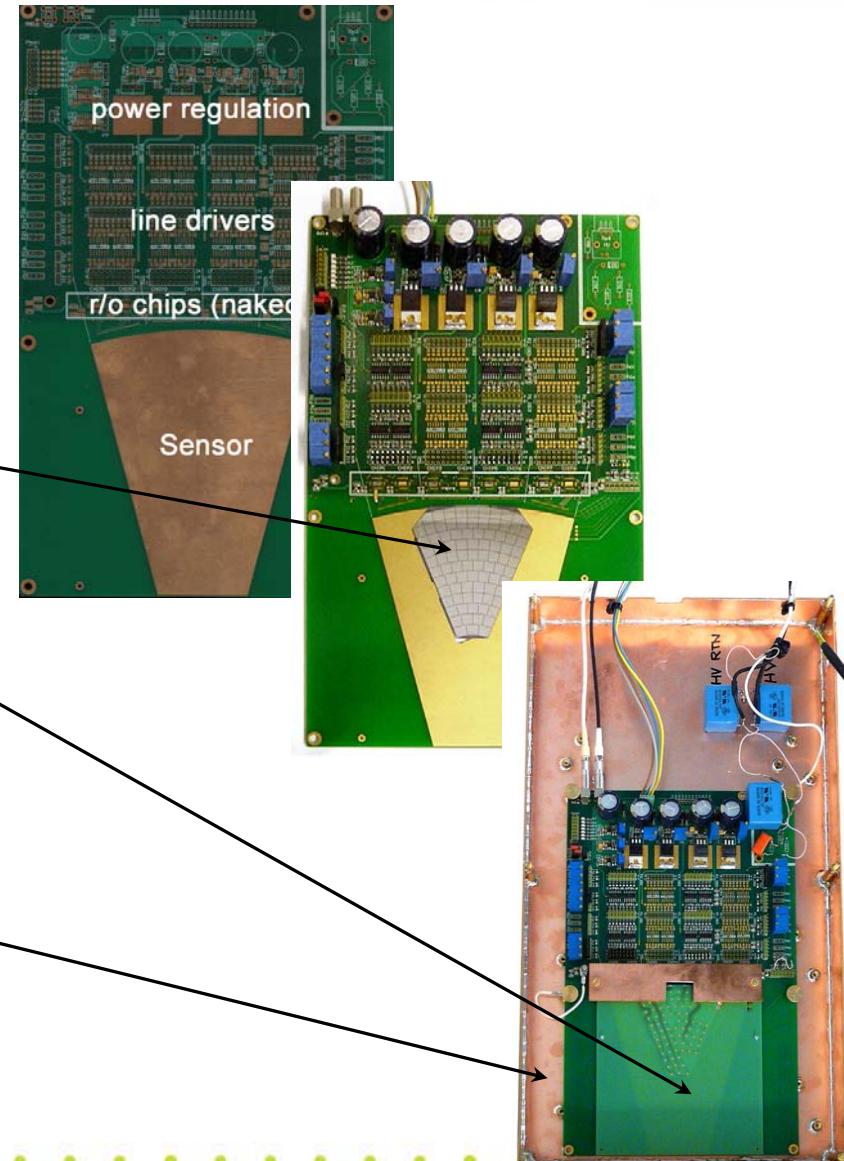
- Power Supplies
- Testpulse coupling
- HV supply & filter

- ADC & DAQ



Frontend Electronics

- RO board w/ PreAmp, Drivers
 - + Sensor
 - + 'Fanout'
- Power Supplies
- Testpulse coupling
- HV supply & filter
- Shielding box
- ADC & DAQ



RO Board (1) (courtesy of AGH Krakow)

Preamplifier ASICs:

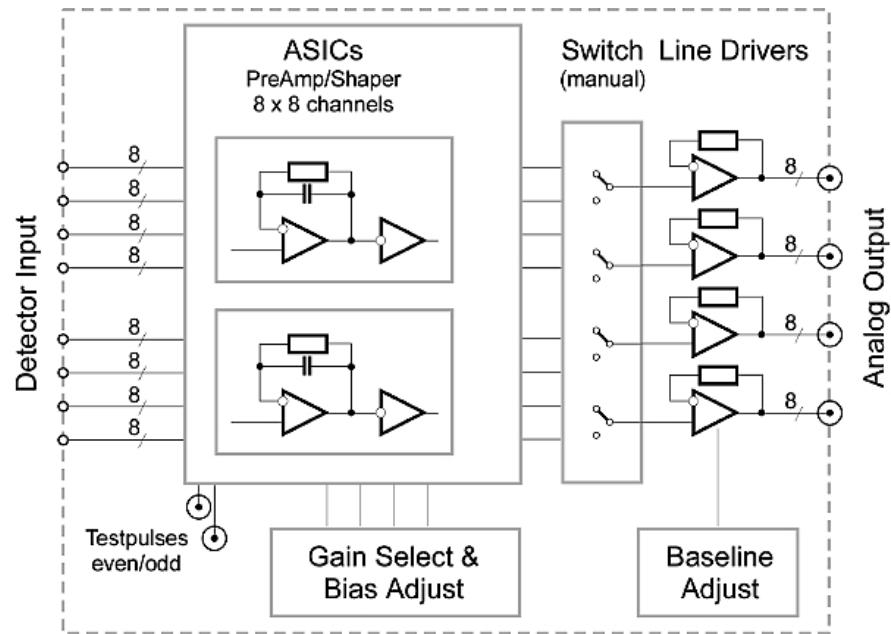
8x8 channels provided

Line Drivers:

4x8 channels provided

Full Chain (Sensor - ADC):

1x8 channels at a time



RO Board (2) (courtesy of AGH Krakow)

Preamplifier ASICs:

8x8 channels provided

Zeuthen board: 4x8 equipped

Line Drivers:

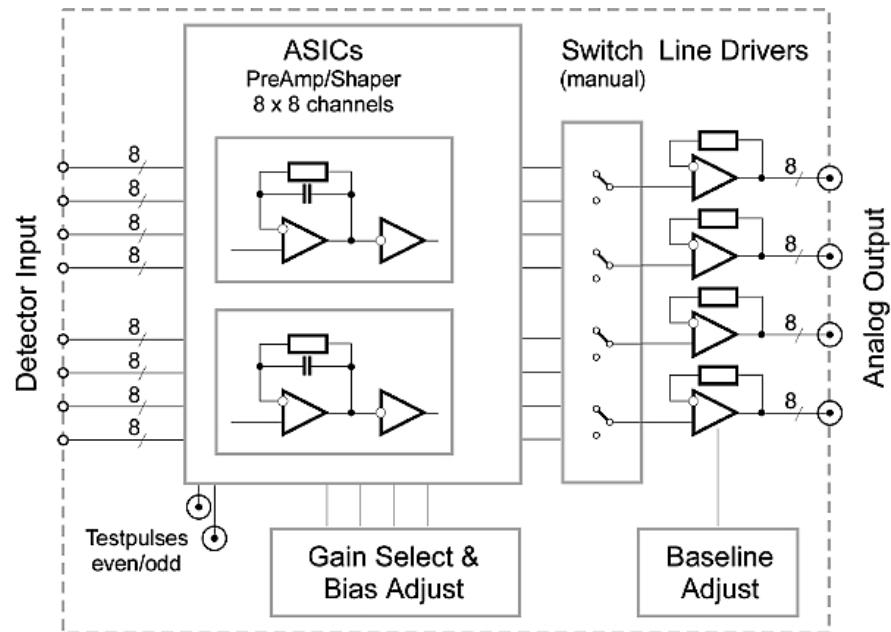
4x8 channels provided

Zeuthen board: 2x8 equipped

Full Chain (Sensor - ADC):

1x8 channels at a time

Zeuthen board: 4x8 channels, selectable



RO Board (3) (courtesy of AGH Krakow)

Preamplifier ASICs:

8x8 channels provided

Zeuthen board: 4x8 equipped,

Line Drivers:

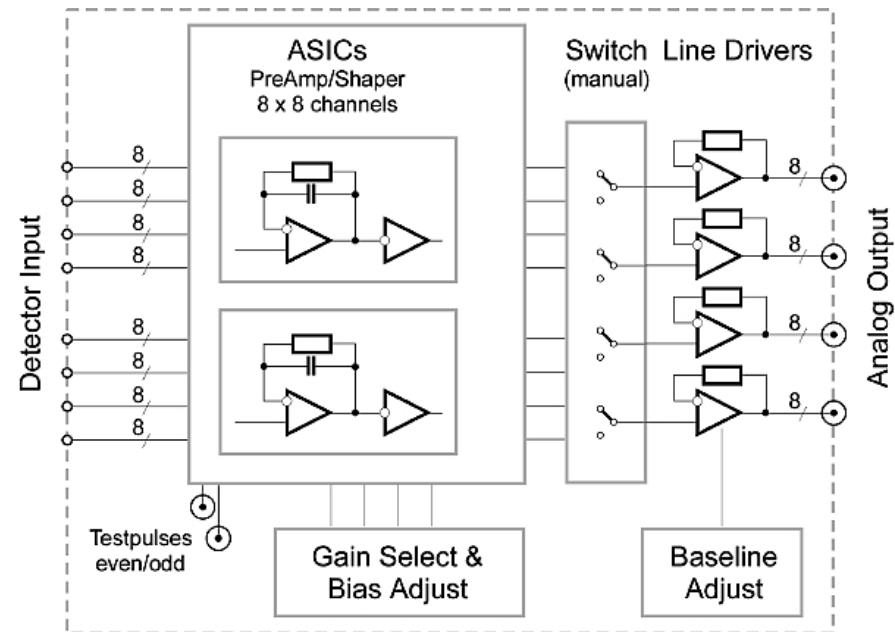
4x8 channels provided

Zeuthen board: 2x8 equipped

Full Chain (Sensor - ADC):

1x8 channels at a time

Zeuthen board: 4x8 channels, selectable



Testbeam: only 3 preamp chains working; all bonds of cluster #1 ruptured

Fanout (1)

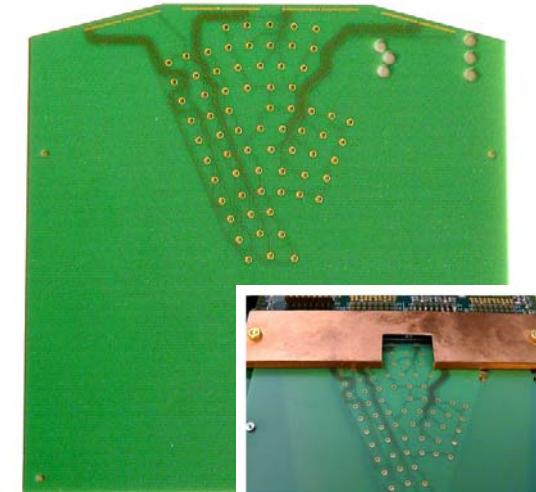
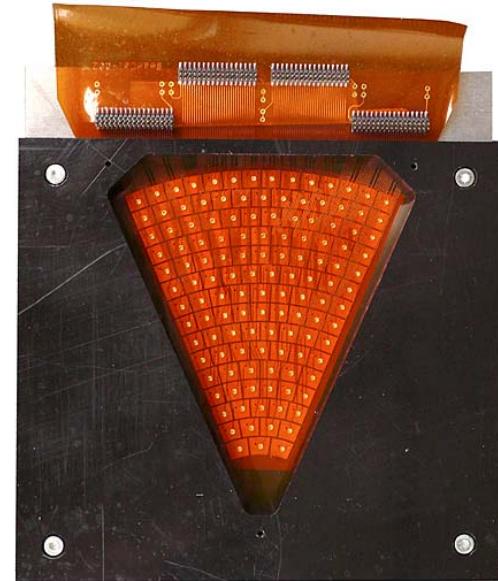
- conventional contacting: wire bonds
- flexible prototype: drawbacks
- GaAs version: 500 μ m pcb

- mount onto RO board, removable
- bonding

to sensor

(through 1.6mm ø holes)

to pcb

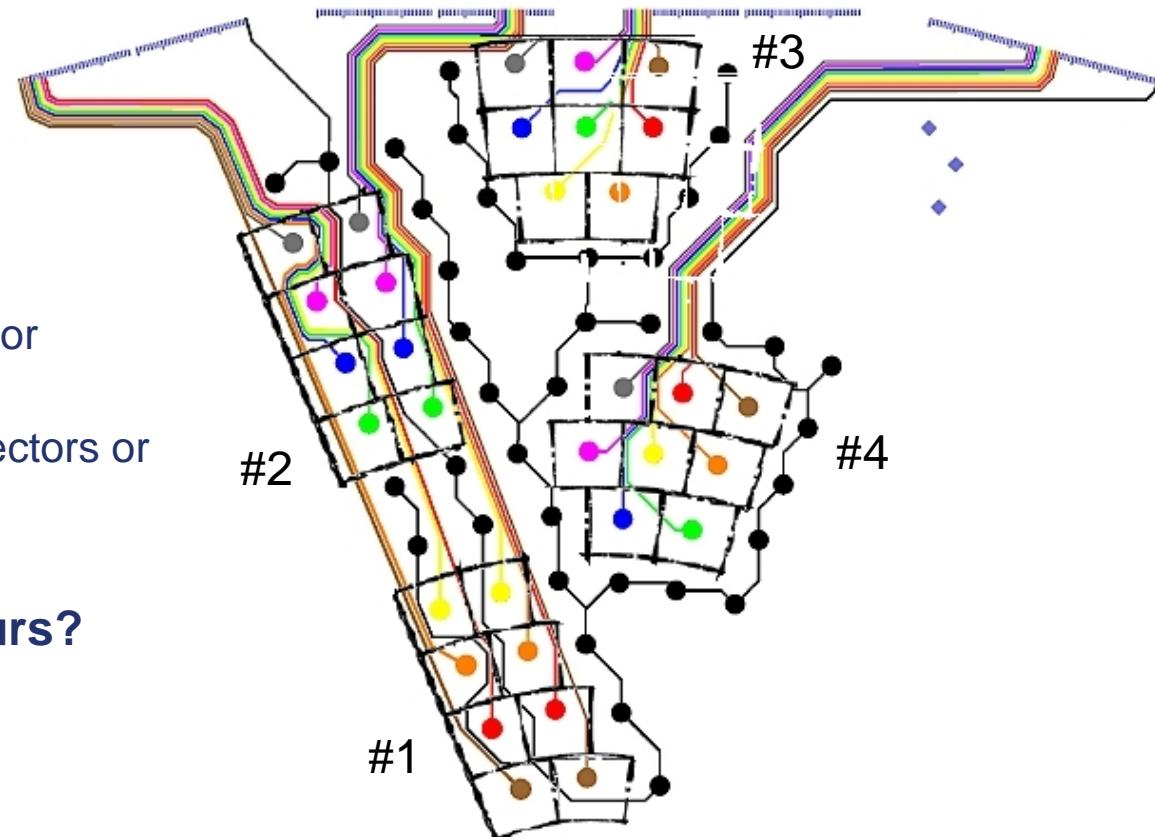


- mechanical protection for bonds mandatory!

Fanout (2)

- **routing of tracks:**
 - a) one chip - one cluster or distributed^{*)})
 - b) consecutive rings & sectors or alternating

- **grounding neighbours?**

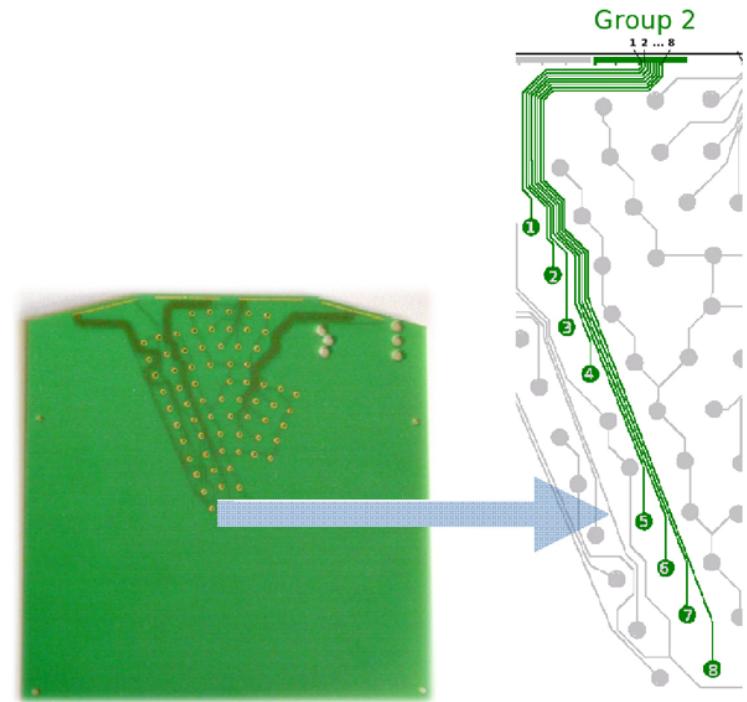


^{*)} → requires special wiring of the RO board

Fanout (3)

Test results

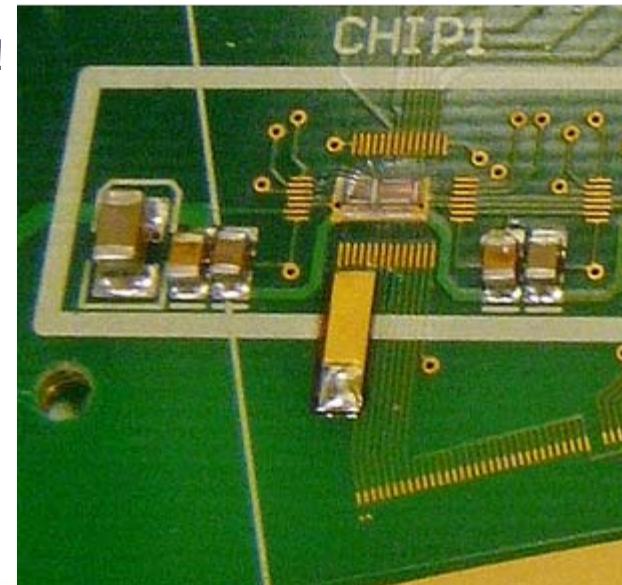
- measurement of parasitic capacitances
- measurement of crosstalk
 - *to be consolidated*



Channel 6 (cluster 2)	vs. Chan 5	vs. Chan 5+7	vs. Chan 5+7+8	vs. all others
Measured	1.60pF	3.29pF	3.64pF	3.98pF
Calculated		3.30pF	3.43pF	

Testpulse

- **provided on the RO board:**
 - even channels - odd channels
 - fine for functional and linearity test
- **for crosstalk measurement:**
 - most channels get crosstalk from **both** neighbours!
 - inject charge through a dedicated capacitor!



Summary

A GaAs pad sensor has been connected to a multi channel RO board with new preamplifier ASICs and successfully tested in a particle beam.

Data are still under investigation - how the signal charge and crosstalk depend on different fanout schemes could not reliably be identified so far.

Many thanks to Szymon & Marek for providing the RO board and to Sandro for assisting in the functionality tests.